

Crystal LTD TM SPEC Form

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Customer

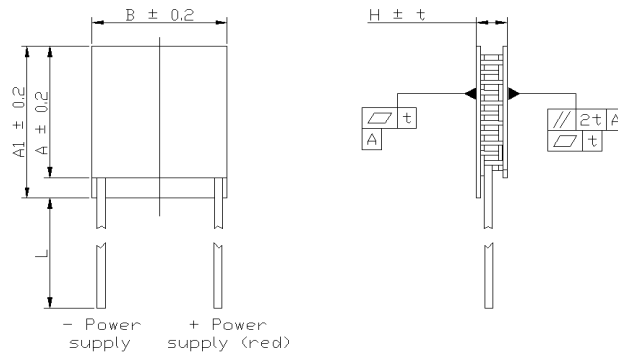
PO#

PO date

Thermoelectric module (TM) specification

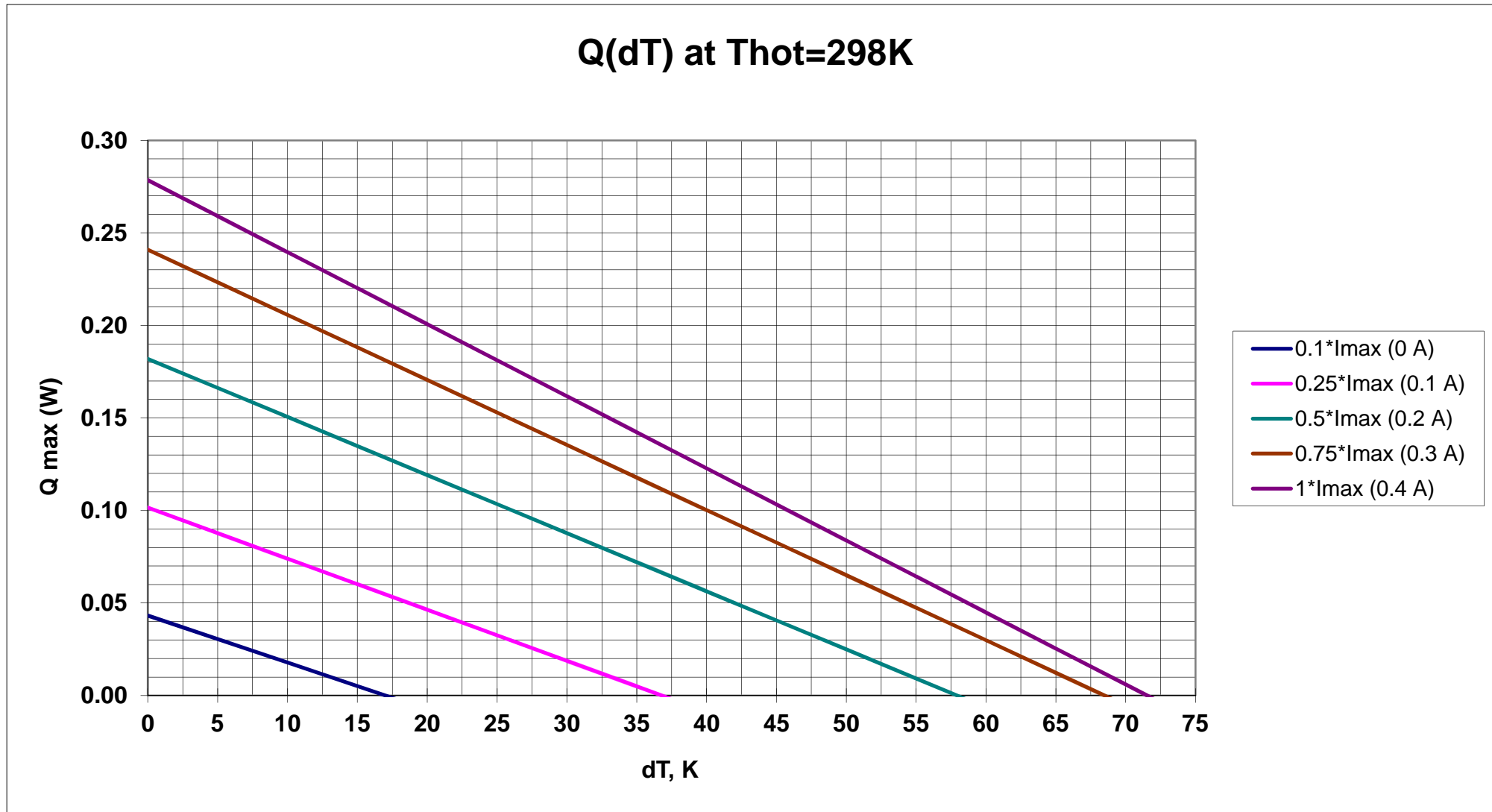
PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short time	long time	Imax, A	Umax, V	Qmax, W	dTmax, K	Rac, Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, AWG #	Length, mm	Tolerance ±, mm	
1	S-008-03-09	138	130	115	0.44	1.02	0.28	71.5	1.76	10	2.5/3.5	2.5	2.05	0.2	30	100	5	
															single solid uninsulated			

Clamping force: 0.1 - 0.2 kg



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Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.



U(dT) at $T_{hot}=298K$

